1.0A SURFACE MOUNT HYPER-FAST RECTIFIER

Product Summary (@ T_A = +25°C)

V_{RRM} (V)	I_O (A)	$V_{F(MAX)}$ (V)	$I_{R(MAX)}$ (µA)
200	1	1.1	5

Features and Benefits

- Low Profile, Small Form Factor Package
- Low Leakage Current
- Glass Passivated for High Reliability
- Hyper-Fast Recovery Time for High Efficiency
- Low Forward Voltage, Low Power Loss
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Description and Applications

The HS1D is a rectifier packaged in the SMA package and is suited as a boost diode in power factor correction circuitry. For use in secondary rectification and freewheeling for superfast switching speed AC-DC and DC-DC converters in high temperature conditions for consumer applications.

- DC-DC Converters
- AC-DC Adaptors/Chargers
- Inverters

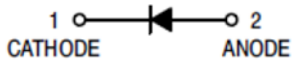
Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e3
- Polarity: Cathode Band
- Weight: 0.064 grams (Approximate)

SMA

Top View

Bottom View



Schematic View

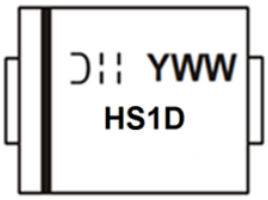
Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
HS1D-13	Commercial	SMA	5,000/Tape & Reel

Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SMA



HS1D = Product Type Marking Code
= Manufacturers' Code Marking
YWW = Date Code Marking
Y = Last Digit of Year (ex: 7 for 2017)
WW = Week Code (01 to 53)

Maximum Ratings and Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	V
Average Rectified Output Current @T_C = +88°C (Note 5)	I_O	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	40	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Terminal (Note 6)	$R_{\theta JT}$	50	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	92	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	200	—	—	V	I_R = 10μA
Forward Voltage Drop	V_F	—	0.87 0.91 0.71	1.1 1.2 —	V	I_F = 1A, T_A = +25°C I_F = 1.5A, T_A = +25°C I_F = 1A, T_A = +125°C
Leakage Current (Note 7)	I_R	—	0.02 1.2	5 100	μA	V_R = 200V, T_A = +25°C V_R = 200V, T_A = +125°C
Reverse Recovery Time	t_{RR}	—	12	15	ns	I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A
Total Capacitance	C_T	—	16	—	pF	V_R = 4.0V_{DC}, f = 1MHz

Notes: 5. Device mounted on FR-4 substrate, 1" x 1", 2oz, single-sided, PC boards with 0.1" x 0.15" copper pad.
6. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad.
7. Short duration pulse test used to minimize self-heating effect.

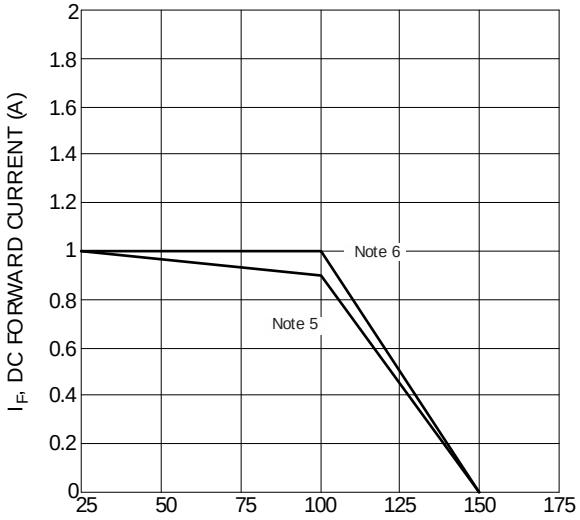


Figure 1 DC Forward Current Derating Curve

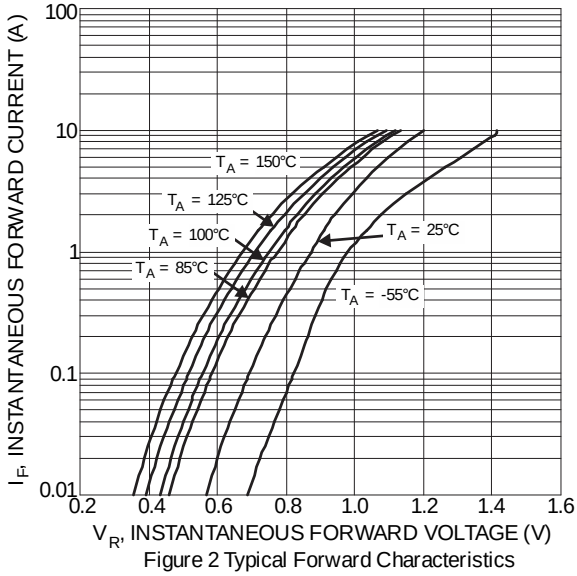


Figure 2 Typical Forward Characteristics

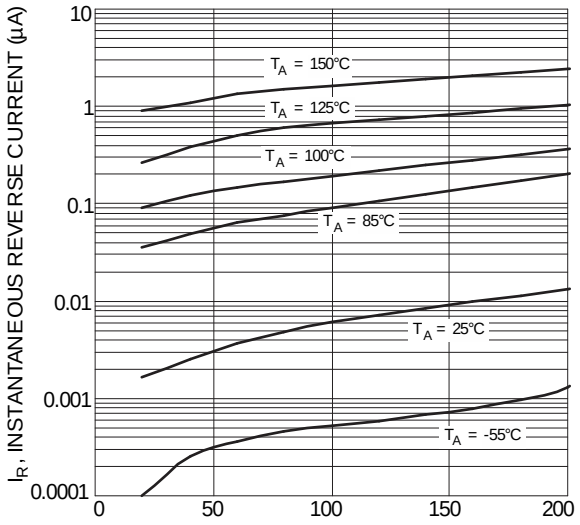


Figure 3 Typical Reverse Characteristics

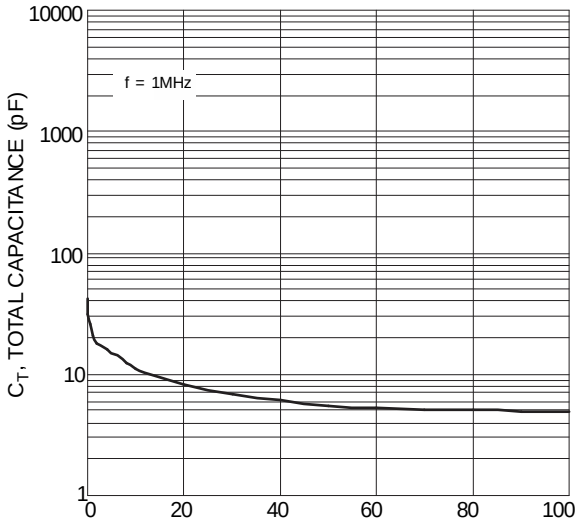


Figure 4 Total Capacitance vs. Reverse Voltage

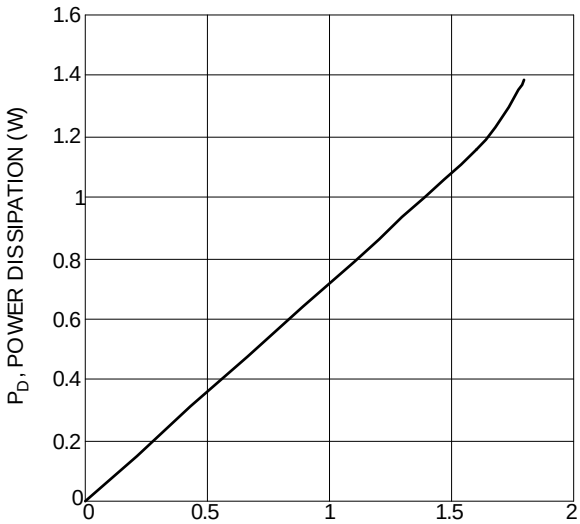


Figure 5 Forward Power Dissipation

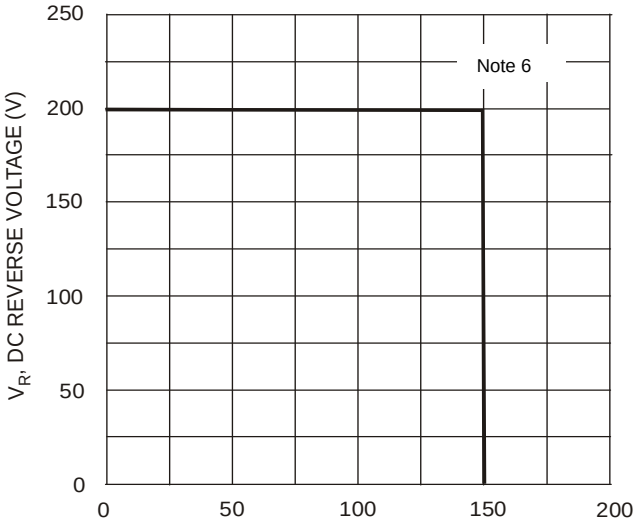
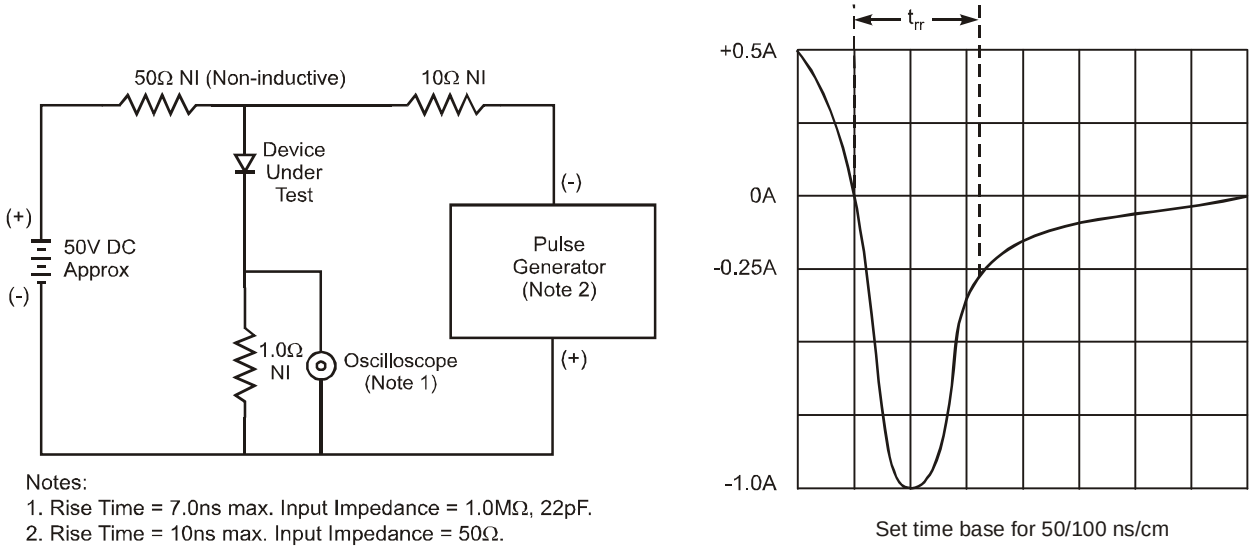


Fig. 6 Operating Temperature Derating



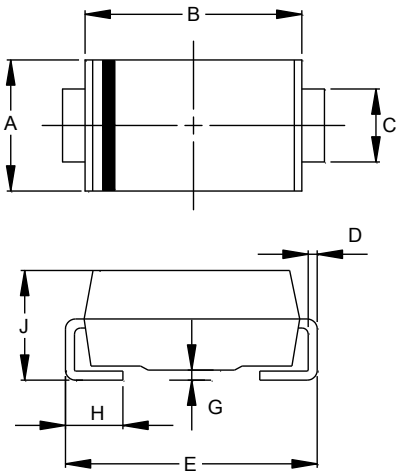
Notes:
1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
2. Rise Time = 10ns max. Input Impedance = 50Ω.

Fig. 7 Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMA

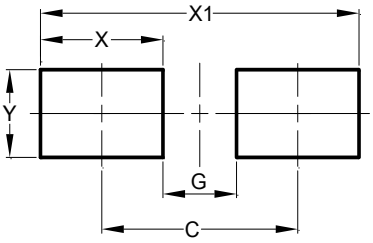


SMA		
Dim	**Min**	**Max**
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	1.96	2.40
All Dimensions in mm		

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMA



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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